

## General Description

This MOSFET uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

## Features

- Low gate charge
- High power and current handing capability
- Lead free product is acquired

## Applications

- Load switch
- Battery protection
- Power management



## Key Performance Parameters

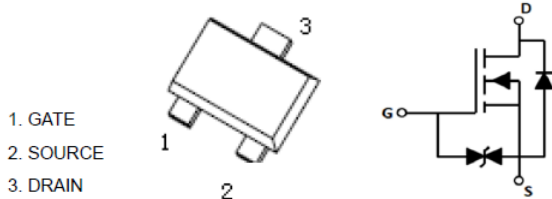
Parameter	Value	Unit
$V_{DS}$	20	V
$R_{DS(ON), max @ V_{GS}=4.5 V}$	330	m $\Omega$

## Marking Information

Product Name	Package	Marking
OSH3134KT	SOT-523	34K

## Package & Pin information

### SOT-523



**Absolute Maximum Ratings** at  $T_j=25^{\circ}\text{C}$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	$V_{DS}$	20	V
Gate-source voltage	$V_{GS}$	$\pm 10$	V
Continuous Drain Current	$I_D$	0.75	A
Pulsed Drain Current <sup>1)</sup>	$I_{D,pulse}$	3.0	A
Power Dissipation	$P_D$	310	mW
Operation and storage temperature	$T_{stg}, T_j$	-55 to 150	$^{\circ}\text{C}$

**Thermal Characteristics**

Parameter	Symbol	Value	Unit
Thermal resistance, junction-to-Ambient	$R_{\theta JA}$	400	$^{\circ}\text{C/W}$

**Electrical Characteristics** at  $T_j=25^{\circ}\text{C}$  unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	$BV_{DSS}$	20			V	$V_{GS}=0\text{ V}, I_D=250\ \mu\text{A}$
Gate threshold voltage	$V_{GS(th)}$	0.35		1.1	V	$V_{DS}=V_{GS}, I_D=250\ \mu\text{A}$
Drain-source on-state resistance	$R_{DS(ON)}$		220	330	$\text{m}\Omega$	$V_{GS}=4.5\text{ V}, I_D=0.5\text{ A}$
			300	480	$\text{m}\Omega$	$V_{GS}=2.5\text{ V}, I_D=0.3\text{ A}$
			450	800	$\text{m}\Omega$	$V_{GS}=1.8\text{ V}, I_D=0.25\text{ A}$
Gate-source leakage current	$I_{GSS}$			10	$\mu\text{A}$	$V_{GS}=10\text{ V}, V_{DS}=0\text{ V}$
				-10		$V_{GS}=-10\text{ V}, V_{DS}=0\text{ V}$
Drain-source leakage current	$I_{DSS}$			1	$\mu\text{A}$	$V_{DS}=20\text{ V}, V_{GS}=0\text{ V}$

### Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		24		pF	$V_{GS}=0\text{ V}$ , $V_{DS}=16\text{ V}$ , $f=1.0\text{ MHz}$
Output capacitance	$C_{oss}$		7.5		pF	
Reverse transfer capacitance	$C_{rss}$		3		pF	
Turn-on Delay Time	$t_{d(on)}$		6.7		ns	$V_{GS}=4.5\text{ V}$ , $V_{DD}=10\text{ V}$ , $I_D=0.5\text{ A}$ , $R_{GEN}=10\ \Omega$
Turn-on Rise Time	$t_r$		4.8		ns	
Turn-Off Delay Time	$t_{d(off)}$		17.3		ns	
Turn-Off Fall Time	$t_f$		7.4		ns	

### Gate Charge Characteristics

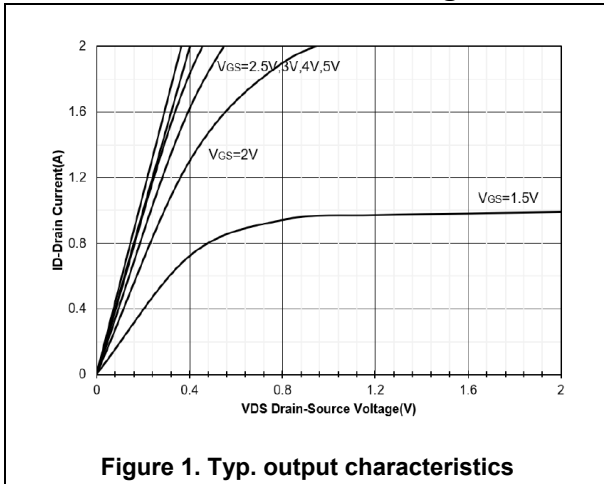
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total Gate Charge	$Q_g$		0.4		nC	$V_{GS}=4.5\text{ V}$ , $V_{DS}=5\text{ V}$ , $I_D=0.5\text{ A}$
Gate-Source Charge	$Q_{gs}$		0.1		nC	
Gate-Drain Charge	$Q_{gd}$		0.15		nC	

### Body Diode Characteristics

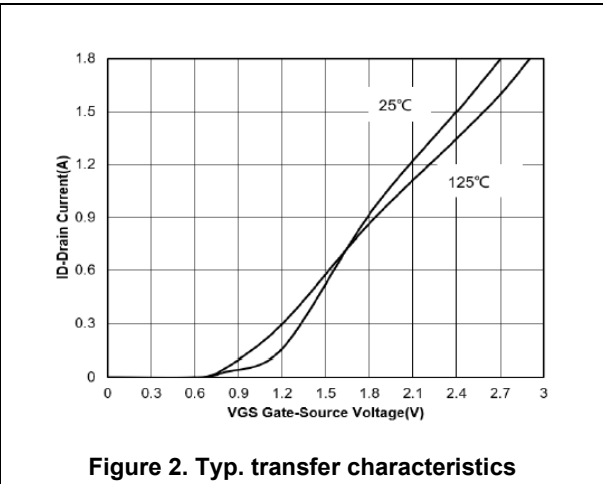
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Source drain current (Body Diode)	$I_{SD}$			0.75	A	$T_A=25^\circ\text{C}$
Diode forward voltage <sup>2)</sup>	$V_{SD}$			1.2	V	$I_S=0.75\text{ A}$ , $V_{GS}=0\text{ V}$

- Note:** 1) Pulse width limited by maximum allowable junction temperature.  
 2) Repetitive Rating: Pulse width limited by maximum junction temperature.

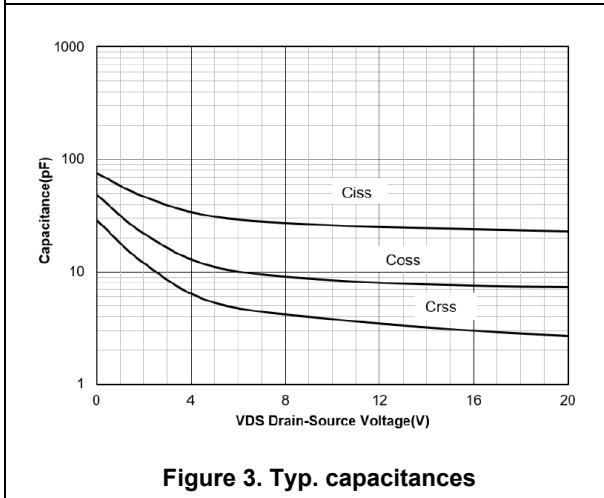
**Electrical Characteristics Diagrams**



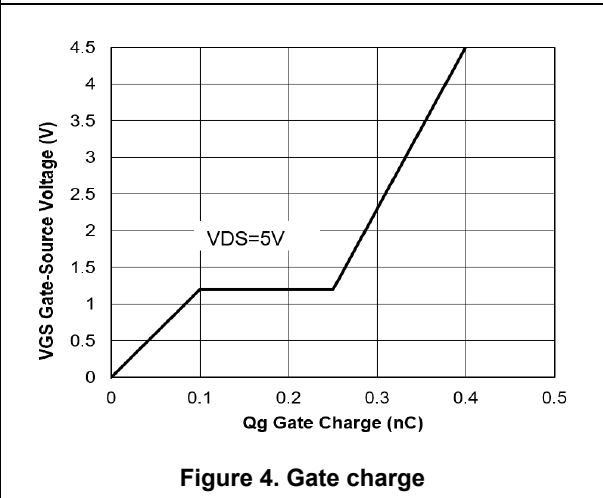
**Figure 1. Typ. output characteristics**



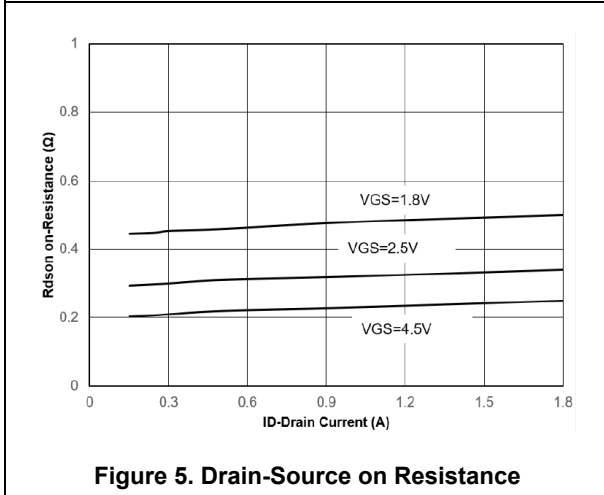
**Figure 2. Typ. transfer characteristics**



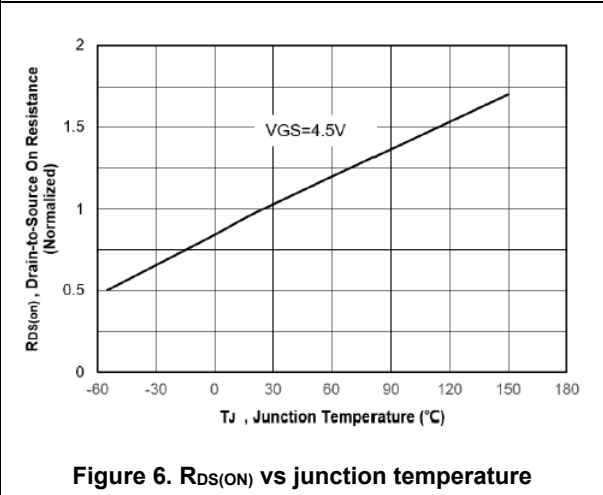
**Figure 3. Typ. capacitances**



**Figure 4. Gate charge**

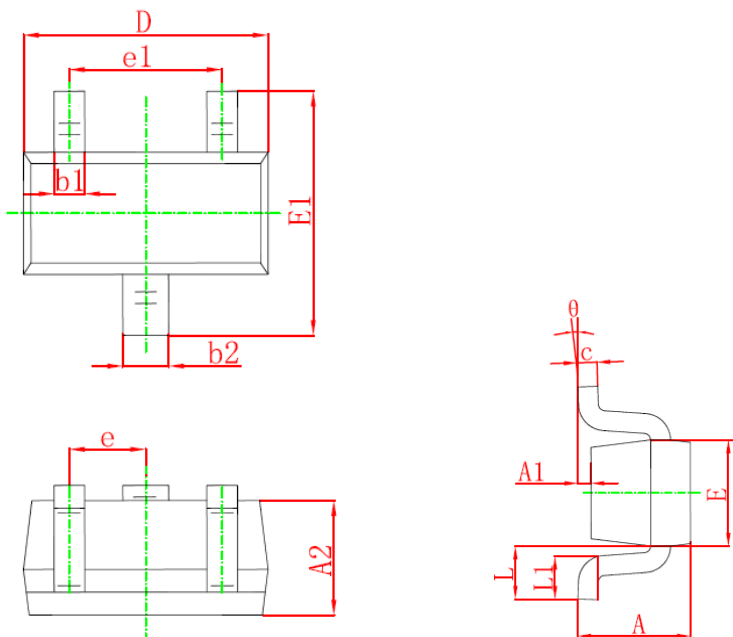


**Figure 5. Drain-Source on Resistance**



**Figure 6.  $R_{DS(ON)}$  vs junction temperature**

**Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

Version: SOT-523-V package outline dimension

**Ordering Information**

Package Type	Units/ Reel	Reels/ Inner Box	Units/ Inner Box	Inner Boxes/ Carton Box	Units/ Carton Box
SOT-523	3000	10	30000	4	120000

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